

10/551695

PATENT

Attorney Docket No. 061063-0318214

Client Reference: OSP-18831

JC09 Rec'd PCT/PTO 30 SEP 2009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: YOSHINOBU NAKADA et al.

Application No.: TBD

Group Art Unit:

Filed: September 30, 2005

Examiner: Unassigned

For: HEAT TREATMENT JIG AND HEAT TREATMENT METHOD FOR SILICON
WAFER

September 30, 2005

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PRELIMINARY AMENDMENT UNDER 37 C.F.R. § 1.115

Mail Stop PCT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to the examination of this application on its merits, please enter the following
amendments and consider the following remarks:

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Client Reference: OSP-18831

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IN THE TITLE

Please delete the title presented by PCT/US2004/004508 and replace it with the following new title:

HEAT TREATMENT JIG AND HEAT TREATMENT METHOD FOR SILICON
WAFER